

HT604L/HT614/HT692 3¹⁸ Series of Decoders

Features

- Operating voltage: 2.4V~12V
- Low power and high noise immunity CMOS technology
- · Low standby current
- Capable of decoding 18 bits of information
- 9~10 address pins
- 2~8 data pins
- · Trinary address setting
- · Two times of receiving check

- · Built-in oscillator needs only a 5% resistor
- · Valid transmission indicator
- Easy interface with an RF or an infrared transmission medium
- Minimal external components
- Pair with Holtek's 3¹⁸ series of encoders
- HT604L/HT614: 20-pin DIP/SOP package HT692: 18-pin DIP package

Applications

- · Burglar alarm system
- · Smoke and fire alarm system
- · Garage door controllers
- · Car door controllers

- Car alarm system
- Security system
- · Cordless telephones
- · Other remote control systems

General Description

The 3¹⁸ decoders are a series of CMOS LSIs for remote control system applications. They are paired with the 3¹⁸ series of encoders. For proper operation, a pair of encoder/decoder pair with the same number of address and data format should be selected (refer to the encoder/decoder cross reference tables).

The 3¹⁸ series of decoders receive serial address and data from that series of encoders that are transmitted by a carrier using an RF or an IR transmission medium. It then compares the serial input data twice continuously with its local address. If no errors or unmatched codes

are encountered, the input data codes are decoded and then transferred to the output pins. The VT pin also goes high to indicate a valid transmission.

The 3¹⁸ decoders are capable of decoding 18 bits of information that consists of N bits of address and 18–N bits of data. To meet various applications they are arranged to provide a number of data pins whose range is from 0 to 8 and an address pin whose range is from 8 to 18. In addition, the 3¹⁸ decoders provide various combinations of address/data number in different packages.

Selection Table

Function	Address	D	ata	VT	Oscillator	Triana	Daakana
Part No.	No.	No.	Туре	VI	Oscillator	Trigger	Package
HT604L	10	4	L	\checkmark	RC oscillator	DIN active "Hi"	20DIP/SOP
HT614	10	4	М	\checkmark	RC oscillator	DIN active "Hi"	20DIP/SOP
HT692	10	2	М	$\sqrt{}$	RC oscillator	DIN active "Hi"	18DIP

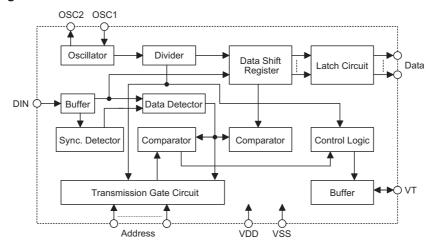
Note: Data type: M stands for momentary type data output.

L stands for latch type data output.

VT can be used as a momentary data output.

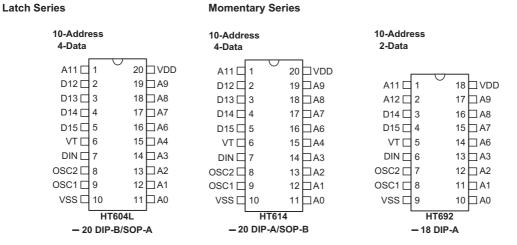


Block Diagram



Note: The address/data pins are available in various combinations (refer to the address/data table).

Pin Assignment



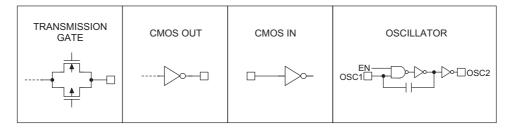
Pin Description

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Pin Name	Pin Name I/O Internal Connection		Description
A0~A12	ı	TRANSMISSION GATE	Input pins for address A0~A12 setting They can be externally set to VDD, VSS or left open.
D10~D17	0	CMOS OUT	Output data pins
DIN	ı	CMOS IN	Serial data input pin
VT	0	CMOS OUT	Valid transmission, active high
OSC1	1	OSCILLATOR	Oscillator input pin
OSC2	0	OSCILLATOR	Oscillator output pin
VSS	_	_	Negative power supply, ground
VDD	_	_	Positive power supply

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Approximate Internal Connections



Absolute Maximum Ratings

Supply VoltageV _{SS} -0.3V to V _{SS} +13V	Storage Temperature50°C to 125°C
Input VoltageV _{SS} -0.3V to V _{DD} +0.3V	Operating Temperature20°C to 75°C

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

Electrical Characteristics

Ta=25°C

Sumb al	Parameter		Test Conditions	Min.	Tres	Max	Unit
Symbol	Parameter	V_{DD}	Conditions	wiin.	Тур.	Max.	
V _{DD}	Operating Voltage	_	_	3	_	12	V
		5V	0 111 4	_	0.1	1	μΑ
I _{STB}	Standby Current	12V	Oscillator stops	_	2	4	μΑ
I _{DD}	Operating Current	5V	No load, f _{OSC} =100kHz	_	0.2	1	mA
	Data Output Source Current (D10~D17)	5) (V _{OH} =4.5V	-0.5	-1	_	mA
lo	Data Output Sink Current (D10~D17)	5V	V _{OL} =0.5V	0.25	1	_	mA
	VT Output Source Current	5) (V _{OH} =4.5V	-2	-4	_	mA
I _{VT}	VT Output Sink Current	5V	V _{OL} =0.5V	0.25	1	_	mA
V _{IH}	"H" Input Voltage	5V	_	3.5	_	5	V
V _{IL}	"L" Input Voltage	5V	_	0	_	1	V
f _{OSC}	Oscillator Frequency	10V	R _{OSC} =330kΩ	_	100	_	kHz

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Functional Description

Operation

The 3¹⁸ series of decoders provide various combinations of address and data pins in different packages. It is paired with the 3¹⁸ series of encoders. The decoders receive data transmitted by the encoders and interpret the first N bits of the code period as address and the last 18-N bits as data (where N is the address code number). A signal on the DIN pin then activates the oscillator which in turns decodes the incoming address and data. The decoders will check the received address twice continuously. If all the received address codes match the contents of the decoder's local address, the 18-N bits of data are decoded to activate the output pins, and the VT pin is set high to indicate a valid transmission. That will last until the address code is incorrect or no signal has been received. The output of the VT pin is high only when the transmission is valid. Otherwise it is always low.

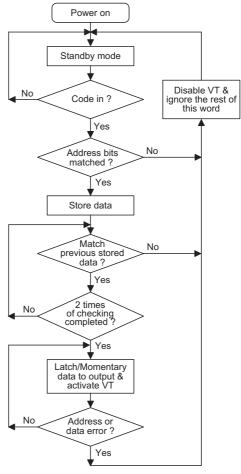
Output Type

There are two types of output to select from:

- Momentary type
- The data outputs follow the encoder during a valid transmission and then reset.
- · Latch type

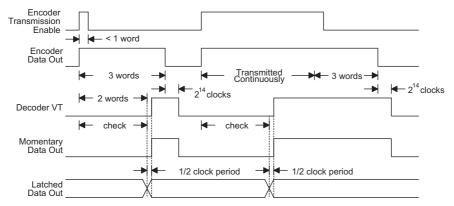
The data outputs follow the encoder during a valid transmission, and are then latched in this state until the next valid transmission occurs.

Flowchart



Note: The oscillator is disabled in the standby state and activated as long as a logic "high" signal is applied to the DIN pin. i.e., the DIN should be kept "low" if there is no signal input.

Decoder timing



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Encoder/Decoder Selection Tables

• Latch type of data output

							Pac	kage		
Part No.	Data Pins	Address Pins	VT	Pair Encoder		Encod	er		Decode	er
	1 1113	1 1113			DIP	SOP	SKDIP	DIP	SOP	SKDIP
1170041	4	40	,	HT600	20	20		00	00	
HT604L	4	10	V	HT6207	20	_	_	20	20	_

• Momentary type of data output

							Pac	kage		
Part No.	Data Pins	Address Pins	VT	Pair Encoder		Encod	er		Decode	er
	1 1113	1 1113			DIP	SOP	SKDIP	DIP	SOP	SKDIP
HT692	2	10	√	HT680	18	_	_	18	_	_
LITCAA	4	10	,	HT600	20	20		20	20	
HT614	4	10	1 1	HT6207	20	_	_	20	20	_

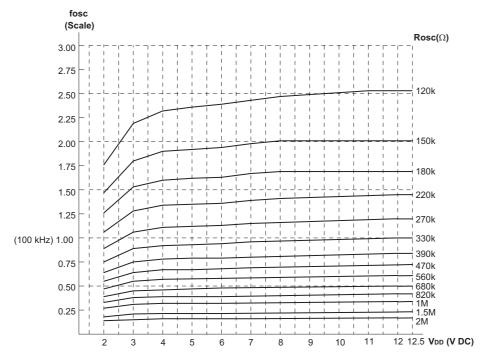
Address/Data Sequence

The following provides a table of address/data sequence for various models of the 3¹⁸ series decoders.

Dort No.		Address/Data Bits										
Part No.	0~3	4	5	6~9	10	11	12	13	14	15	16	17
HT604L	A0~A3	A4	_	A6~A9	_	A11	D12	D13	D14	D15	_	_
HT614	A0~A3	A4	_	A6~A9	_	A11	D12	D13	D14	D15	_	_
HT692	A0~A3	_	_	A6~A9	_	A11	A12	_	D14	D15	_	_

Note: "—" is a dummy code which is left "open" and not bonded out.

Oscillator Frequency vs. Supply Voltage

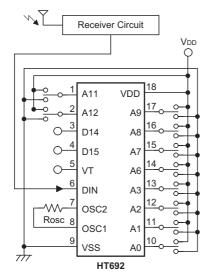


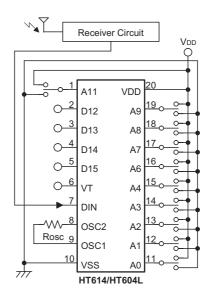
The recommended oscillator frequency is f_{OSCD} (decoder) $\cong f_{OSCE}$ (encoder)

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Application Circuits



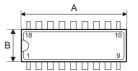


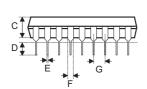


Package Information

18-pin DIP (300mil) Outline Dimensions









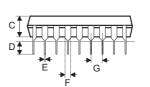




Fig1. Full Lead Packages

Fig2. 1/2 Lead Packages

• MS-001d (see fig1)

Symbol		Dimensions in mil	
Symbol	Min.	Nom.	Max.
A	880	_	920
В	240	_	280
С	115	_	195
D	115	_	150
Е	14	_	22
F	45	_	70
G	_	100	_
Н	300	_	325
I	_	_	430

• MS-001d (see fig2)

Symbol	Dimensions in mil							
Symbol	Min.	Nom.	Max.					
А	845	_	880					
В	240	_	280					
С	115	_	195					
D	115	_	150					
E	14	_	22					
F	45	_	70					
G	_	100	_					
Н	300	_	325					
I	_	_	430					

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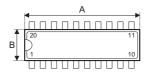
• MO-095a (see fig2)

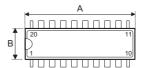
Symbol		Dimensions in mil	
Symbol	Min.	Nom.	Max.
Α	845	_	885
В	275	_	295
С	120	_	150
D	110	_	150
E	14	_	22
F	45	_	60
G	_	100	_
Н	300	_	325
I	_	_	430

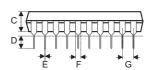
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20-pin DIP (300mil) Outline Dimensions









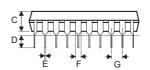




Fig1. Full Lead Packages

Fig2. 1/2 Lead Packages

• MS-001d (see fig1)

Cymphal	Dimensions in mil								
Symbol	Min.	Nom.	Max.						
А	980	_	1060						
В	240	_	280						
С	115	_	195						
D	115	_	150						
E	14	_	22						
F	45	_	70						
G	_	100	_						
Н	300	_	325						
I	_	_	430						

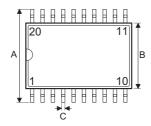
• MO-095a (see fig2)

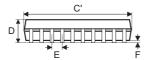
Comple at		Dimensions in mil	
Symbol	Min.	Nom.	Max.
Α	945	_	985
В	275	_	295
С	120	_	150
D	110	_	150
E	14	_	22
F	45	_	60
G	_	100	_
Н	300	_	325
I	_	_	430

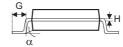
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20-pin SOP (300mil) Outline Dimensions







• MS-013

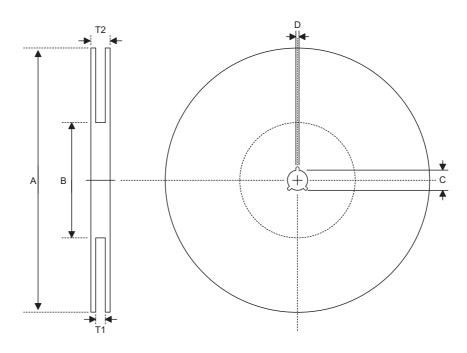
Symbol	Dimensions in mil		
	Min.	Nom.	Max.
Α	393	_	419
В	256	_	300
С	12	_	20
C'	496	_	512
D	_	_	104
E	_	50	_
F	4	_	12
G	16		50
Н	8	_	13
α	0°	_	8°

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Product Tape and Reel Specifications

Reel Dimensions



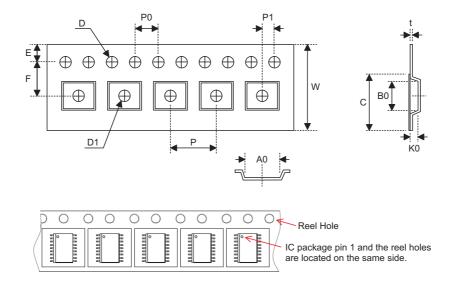
SOP 20W

Symbol	Description	Dimensions in mm
Α	Reel Outer Diameter	330.0±1.0
В	Reel Inner Diameter	100.0±1.5
С	Spindle Hole Diameter	13.0 ^{+0.5/-0.2}
D	Key Slit Width	2.0±0.5
T1	Space Between Flange	24.8 ^{+0.3/-0.2}
T2	Reel Thickness	30.2±0.2

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Carrier Tape Dimensions



SOP 20W

Symbol	Description	Dimensions in mm
W	Carrier Tape Width	24.0 ^{+0.3/-0.1}
Р	Cavity Pitch	12.0±0.1
E	Perforation Position	1.75±0.10
F	Cavity to Perforation (Width Direction)	11.5±0.1
D	Perforation Diameter	1.5 ^{+0.1/-0.0}
D1	Cavity Hole Diameter	1.50 ^{+0.25/-0.00}
P0	Perforation Pitch	4.0±0.1
P1	Cavity to Perforation (Length Direction)	2.0±0.1
A0	Cavity Length	10.8±0.1
В0	Cavity Width	13.3±0.1
K0	Cavity Depth	3.2±0.1
t	Carrier Tape Thickness	0.30±0.05
С	Cover Tape Width	21.3±0.1

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Holtek Semiconductor Inc. (Headquarters)

No.3, Creation Rd. II, Science Park, Hsinchu, Taiwan Tel: 886-3-563-1999 Fax: 886-3-563-1189 http://www.holtek.com.tw

Holtek Semiconductor Inc. (Taipei Sales Office)

4F-2, No. 3-2, YuanQu St., Nankang Software Park, Taipei 115, Taiwan

Tel: 886-2-2655-7070 Fax: 886-2-2655-7373

Fax: 886-2-2655-7383 (International sales hotline)

Holtek Semiconductor Inc. (Shanghai Sales Office)

G Room, 3 Floor, No.1 Building, No.2016 Yi-Shan Road, Minhang District, Shanghai, China 201103

Tel: 86-21-5422-4590 Fax: 86-21-5422-4705 http://www.holtek.com.cn

Holtek Semiconductor Inc. (Shenzhen Sales Office)

5F, Unit A, Productivity Building, Gaoxin M 2nd, Middle Zone Of High-Tech Industrial Park, ShenZhen, China 518057

Tel: 86-755-8616-9908, 86-755-8616-9308

Fax: 86-755-8616-9722

Holtek Semiconductor Inc. (Beijing Sales Office)

Suite 1721, Jinyu Tower, A129 West Xuan Wu Men Street, Xicheng District, Beijing, China 100031

Tel: 86-10-6641-0030, 86-10-6641-7751, 86-10-6641-7752

Fax: 86-10-6641-0125

Holtek Semiconductor Inc. (Chengdu Sales Office)

709, Building 3, Champagne Plaza, No.97 Dongda Street, Chengdu, Sichuan, China 610016

Tel: 86-28-6653-6590 Fax: 86-28-6653-6591

Holtek Semiconductor (USA), Inc. (North America Sales Office)

46729 Fremont Blvd., Fremont, CA 94538, USA

Tel: 1-510-252-9880 Fax: 1-510-252-9885 http://www.holtek.com

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